

HAT2175H

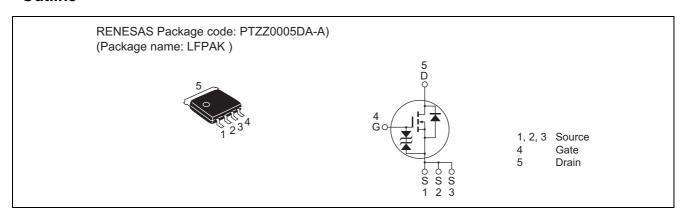
Silicon N Channel Power MOS FET Power Switching

REJ03G0006-0400 Rev.4.00 Sep 20, 2005

Features

- Capable of 8 V gate drive
- Low drive current
- High density mounting
- Low on-resistance $R_{DS(on)} = 33 \text{ m}\Omega \text{ typ. (at } V_{GS} = 10 \text{ V})$

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit	
Drain to source voltage	V _{DSS}	100	V	
Gate to source voltage	V_{GSS}	± 20	V	
Drain current	I _D	15	А	
Drain peak current	I _{D(pulse)} Note1	60	А	
Body-drain diode reverse drain current	I _{DR}	15	А	
Avalanche current	I _{AP} Note 2	15	А	
Avalanche energy	E _{AR} Note 2	22.5	mJ	
Channel dissipation	Pch Note3	15	W	
Channel to Case Thermal Resistance	θch-C	8.34	°C/W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at Tch = 25°C, Rg \geq 50 Ω

3. Tc = 25°C

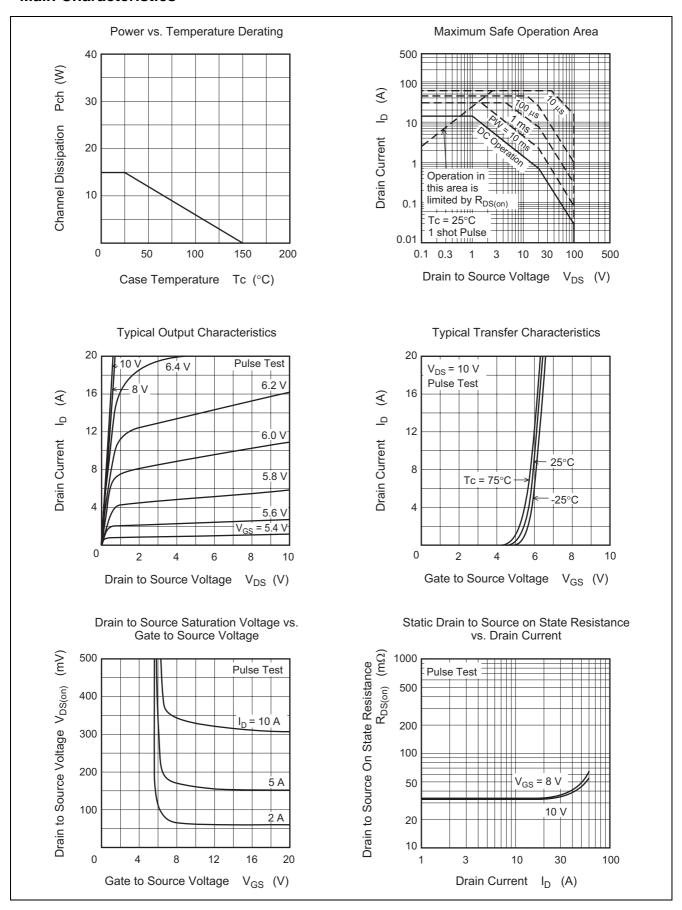
Electrical Characteristics

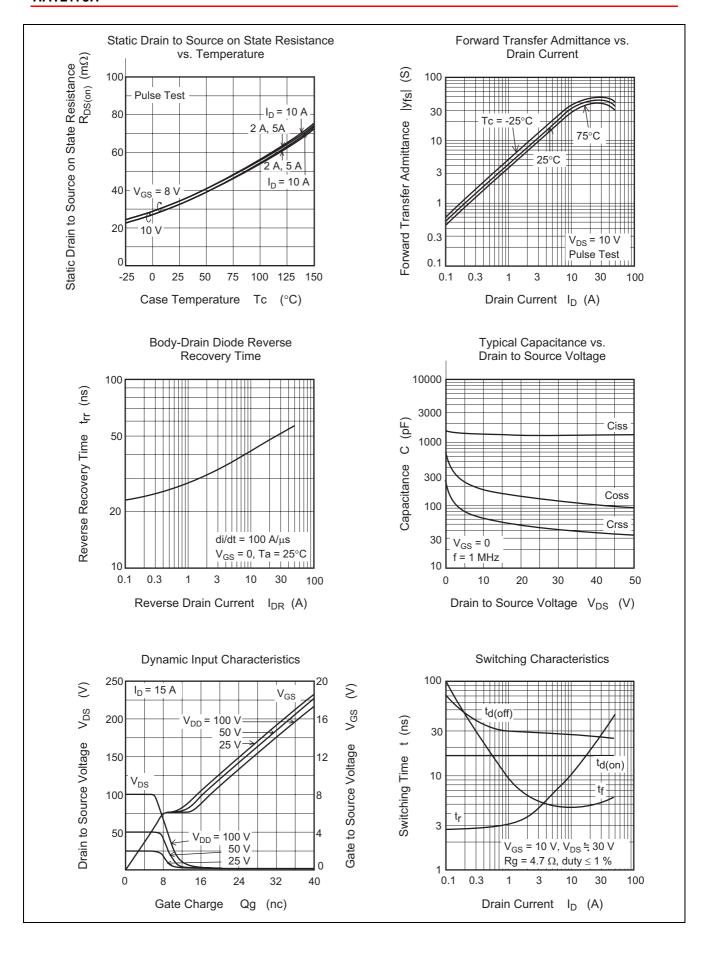
 $(Ta = 25^{\circ}C)$

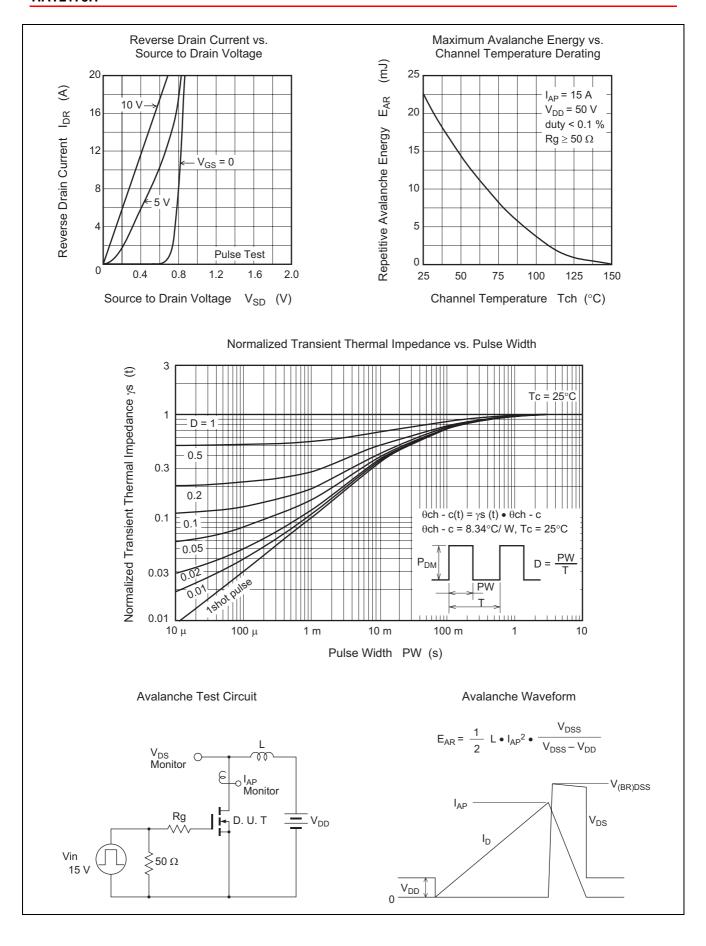
Item	Symbol	Min	Тур	Max	Unit	Test Conditions	
Drain to source breakdown voltage	$V_{(BR)DSS}$	100	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$	
Gate to source breakdown voltage	$V_{(BR)GSS}$	± 20			٧	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$	
Gate to source leak current	I _{GSS}	_		± 10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$	
Zero gate voltage drain current	I _{DSS}	_		1	μΑ	$V_{DS} = 100 \text{ V}, V_{GS} = 0$	
Gate to source cutoff voltage	$V_{GS(off)}$	4.0		6.0	>	$V_{DS} = 10 \text{ V}, I_D = 20\text{mA}$	
Static drain to source on state	R _{DS(on)}	_	33	42	$m\Omega$	$I_D = 7.5 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$	
resistance	R _{DS(on)}	_	34	46	$m\Omega$	$I_D = 7.5 \text{ A}, V_{GS} = 8 \text{ V}^{\text{Note4}}$	
Forward transfer admittance	y _{fs}	15	25	_	S	$I_D = 7.5 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$	
Input capacitance	Ciss	_	1445		pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$	
Output capacitance	Coss	_	185	_	pF	f = 1 MHz	
Reverse transfer capacitance	Crss	_	61	_	pF		
Gate Resistance	Rg	_	0.55	_	Ω		
Total gate charge	Qg	_	21	_	nC	$V_{DD} = 50 \text{ V}, V_{GS} = 10 \text{ V},$	
Gate to source charge	Qgs	_	8	_	nC	$I_D = 15 A$	
Gate to drain charge	Qgd	_	4.5	_	nC		
Turn-on delay time	t _{d(on)}	_	17	_	ns	$V_{GS} = 10 \text{ V}, I_D = 7.5 \text{ A},$	
Rise time	t _r	_	8.2	_	ns	$V_{DD} \cong 30 \text{ V}, R_L = 4 \Omega,$	
Turn-off delay time	t _{d(off)}	_	28	_	ns	$Rg = 4.7 \Omega$	
Fall time	t _f	_	4.7	_	ns		
Body-drain diode forward voltage	V_{DF}	_	0.84	1.10	V	IF = 15 A, V _{GS} = 0 Note4	
Body-drain diode reverse recovery	t _{rr}	_	45	_	ns	IF = 15 A, V _{GS} = 0,	
time						$di_F/dt = 100 \text{ A/ } \mu\text{s}$	

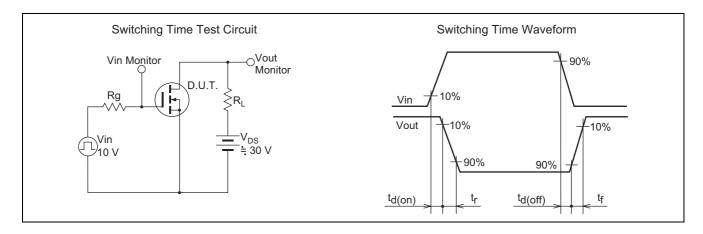
Notes: 4. Pulse test

Main Characteristics

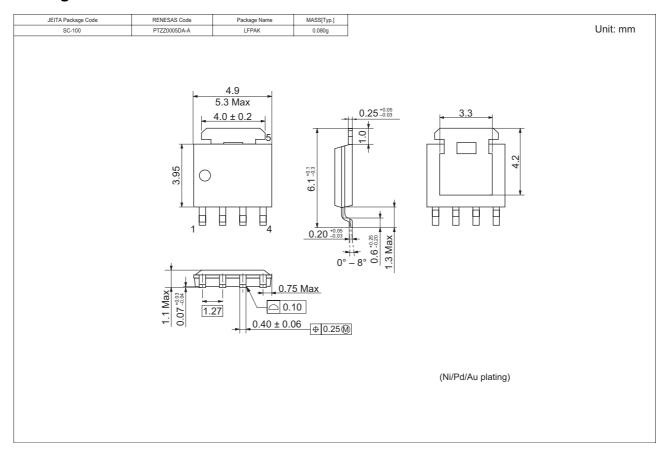








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT2175H-EL-E	2500 pcs	Taping

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